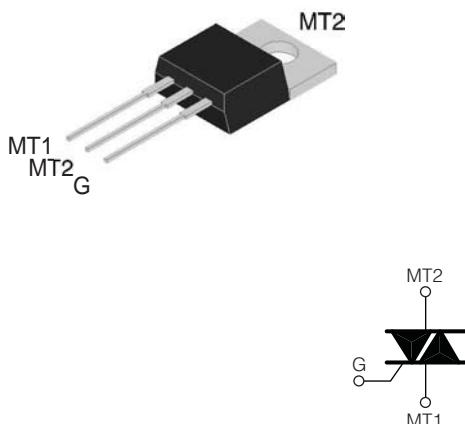


## LOGIC LEVEL TRIAC

## TO-220A B


**On-State Current**

16 Amp

**Gate Trigger Current**

&lt; 10 mA

**Off-State Voltage**

200 V ÷ 800 V

This series of TRIACs uses a high performance PNPN technology.

These parts are intended for general purpose AC switching applications with highly inductive loads.

## Absolute Maximum Ratings, according to IEC publication No. 134

SYMBOL	PARAMETER	CONDITIONS	Value	Unit
$I_{T(RMS)}$	RMS On-state Current (full sine wave)	All Conduction Angle, $T_C = 95^\circ\text{C}$	16	A
$I_{TSM}$	Non-repetitive On-State Current	Full Cycle, 60 Hz ( $t = 16.7 \text{ ms}$ )	176	A
$I_{TSM}$	Non-repetitive On-State Current	Full Cycle, 50 Hz ( $t = 20 \text{ ms}$ )	160	A
$I^2t$	Fusing Current	$t_p = 10 \text{ ms}$ , Half Cycle	144	$\text{A}^2\text{s}$
$I_{GM}$	Peak Gate Current	$20 \mu\text{s}$ max. $T_j = 125^\circ\text{C}$	4	A
$P_{G(AV)}$	Average Gate Power Dissipation	$T_j = 125^\circ\text{C}$	1	W
$dI/dt$	Critical rate of rise of on-state current	$I_G = 2x I_{GT}$ , $t_r \leq 100\text{ns}$ $f = 120 \text{ Hz}$ , $T_j = 125^\circ\text{C}$	50	$\text{A}/\mu\text{s}$
$T_j$	Operating Temperature		(-40 + 125)	$^\circ\text{C}$
$T_{stg}$	Storage Temperature		(-40 + 150)	$^\circ\text{C}$
$T_{sld}$	Soldering Temperature	10s max	260	$^\circ\text{C}$

SYMBOL	PARAMETER	VOLTAGE					Unit
		B	D	M	S	N	
$V_{DRM}$	Repetitive Peak Off State Voltage	200	400	600	700	800	V
$V_{RRM}$							

## LOGIC LEVEL TRIAC

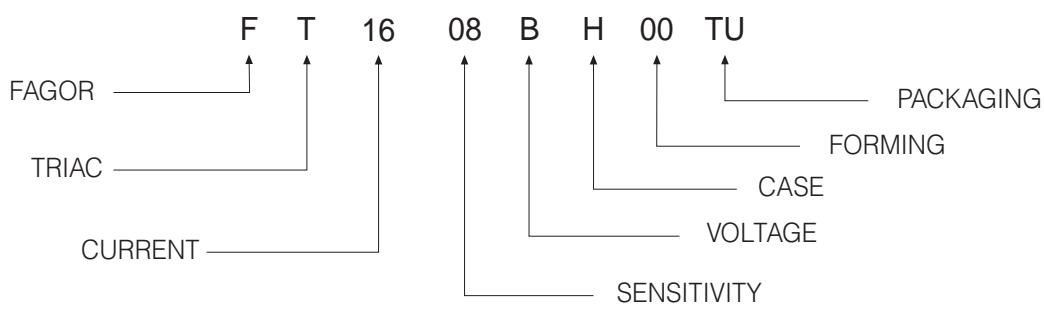
## Electrical Characteristics

SYMBOL	PARAMETER	CONDITIONS	Quadrant	SENSITIVITY		Unit
				08	Q1÷Q3	
$I_{GT}^{(1)}$	Gate Trigger Current	$V_D = 12 \text{ V}_{DC}$ , $R_L = 33\Omega$ , $T_j = 25^\circ\text{C}$	Q1÷Q3 Q4	MAX	10	mA
				MAX		mA
$V_{GT}$	Gate Trigger Voltage	$V_D = 12 \text{ V}_{DC}$ , $R_L = 33\Omega$ , $T_j = 25^\circ\text{C}$	Q1÷Q3 Q1÷Q4	MAX	1.3	V
				MAX		V
$V_{GD}$	Gate Non Trigger Voltage	$V_D = V_{DRM}$ , $R_L = 3.3 \text{ K}\Omega$ , $T_j = 125^\circ\text{C}$	Q1÷Q3 Q1÷Q4	MIN	0.2	V
				MIN		V
$I_H^{(2)}$	Holding Current	$I_T = 100 \text{ mA}$ , Gate open, $T_j = 25^\circ\text{C}$		MAX	15	mA
$I_L$	Latching Current	$I_G = 1.2 I_{GT}$ , $T_j = 25^\circ\text{C}$	Q1,Q3 Q1,Q3,Q4 Q2	MAX	25	mA
				MAX		mA
				MAX	30	mA
$dV/dt^{(2)}$	Critical Rate of Voltage Rise	$V_D = 0.67 \times V_{DRM}$ , Gate open $T_j = 125^\circ\text{C}$		MIN	40	V/ $\mu$ s
$(dI/dt)c^{(2)}$	Critical Rate of Current Rise	$(dI/dt)c = 0.1 \text{ V}/\mu\text{s}$ $T_j = 125^\circ\text{C}$		MIN	8.5	A/ms
		$(dI/dt)c = 10 \text{ V}/\mu\text{s}$ $T_j = 125^\circ\text{C}$		MIN	3.0	A/ms
		without snubber $T_j = 125^\circ\text{C}$		MIN	-	
$V_{TM}^{(2)}$	On-state Voltage	$I_T = 22.5 \text{ Amp}$ , $t_p = 380 \mu\text{s}$ , $T_j = 25^\circ\text{C}$		MAX	1.6	V
$V_{t(o)}^{(2)}$	Threshold Voltage	$T_j = 125^\circ\text{C}$		MAX	0.85	V
$r_d^{(2)}$	Dynamic resistance	$T_j = 125^\circ\text{C}$		MAX	25	$\text{m}\Omega$
$I_{DRM}/I_{RRM}$	Off-State Leakage Current	$V_D = V_{DRM}$ , $T_j = 125^\circ\text{C}$ $V_R = V_{RRM}$ , $T_j = 25^\circ\text{C}$		MAX	2	mA
$R_{th(j-c)}$	Thermal Resistance Junction-Case	for AC 360° conduction angle			1.1	$^\circ\text{C}/\text{W}$
$R_{th(j-a)}$	Thermal Resistance Junction-Ambient	$S = 1 \text{ cm}^2$			60	$^\circ\text{C}/\text{W}$

(1) Minimum  $I_{GT}$  is guaranteed at 5% of  $I_{GT}$  max.

(2) For either polarity of electrode MT2 voltage with reference to electrode MT1.

## PART NUMBER INFORMATION



## LOGIC LEVEL TRIAC

Fig. 1: Maximum power dissipation versus RMS on-state current (full cycle).

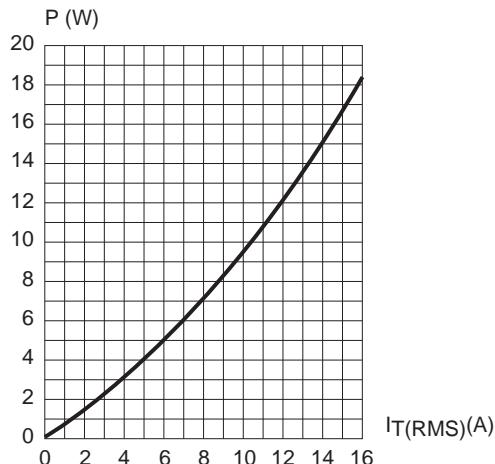


Fig. 2: RMS on-state current versus case temperature (full cycle).

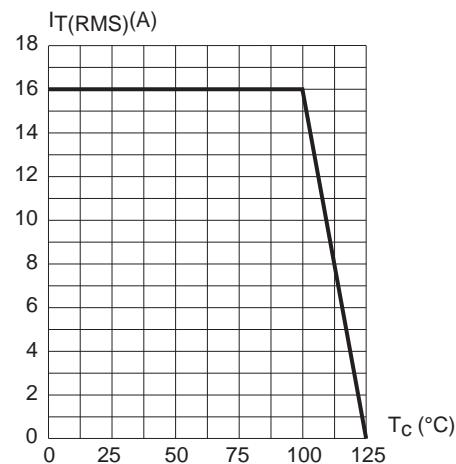


Fig. 3: Relative variation of thermal impedance versus pulse duration.

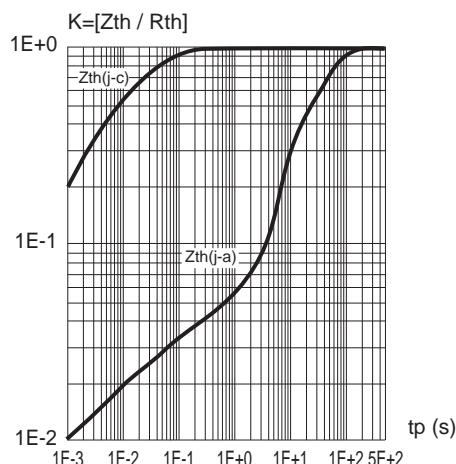


Fig. 5: Surge peak on-state current versus number of cycles

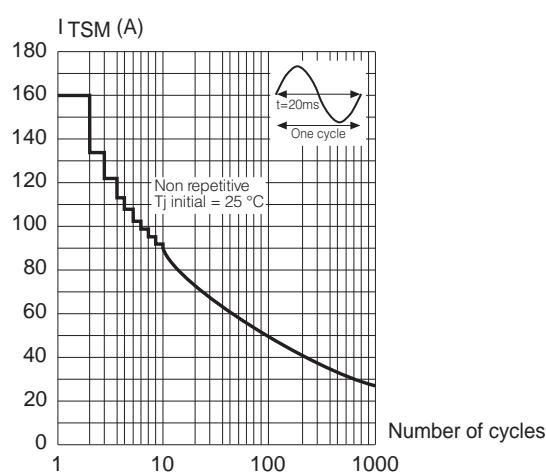


Fig. 4: On-state characteristics (maximum values)

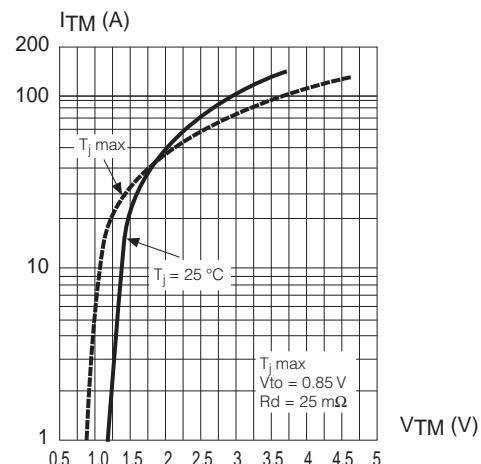
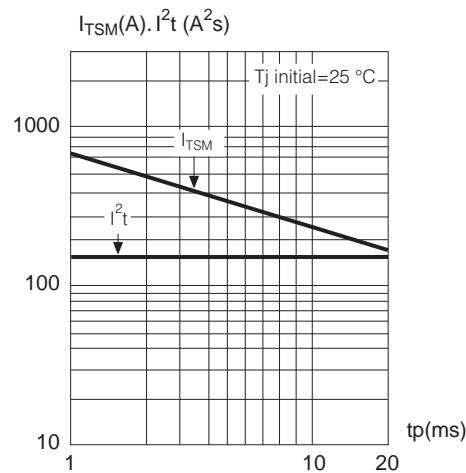


Fig. 6: Non repetitive surge peak on-state current for a sinusoidal pulse with width: tp < 10 ms, and corresponding value of  $i^2 t$ .



## LOGIC LEVEL TRIAC

Fig. 7: Relative variation of gate trigger current, holding current and latching versus junction temperature (typical values)

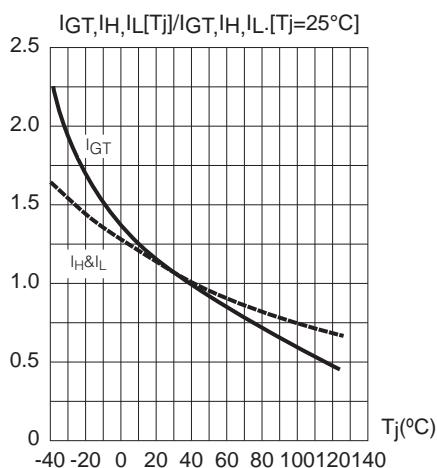


Fig. 8: Relative variation of critical rate of decrease of main current versus junction temperature

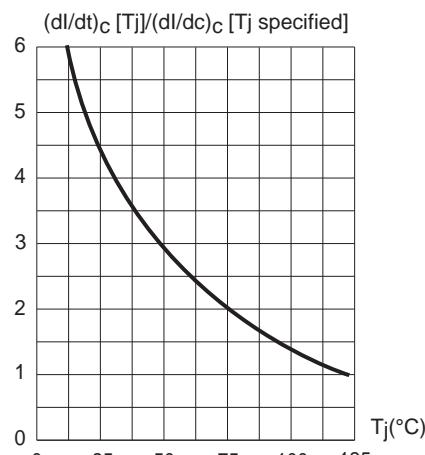
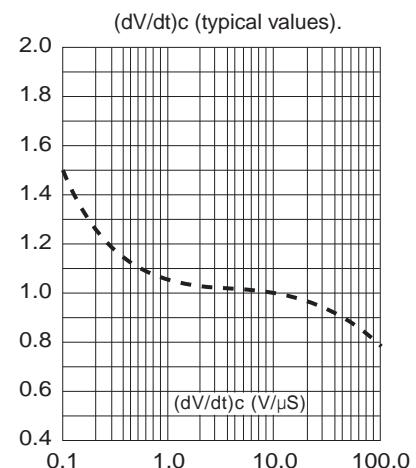
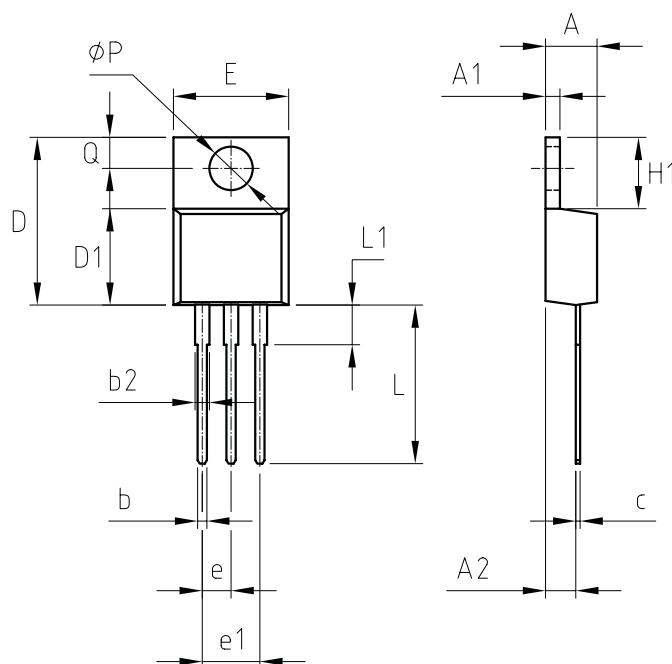


Fig. 9: Relative variation of critical rate of decrease of main current versus



### PACKAGE MECHANICAL DATA

#### TO-220AB



REF.	DIMENSIONS	
	Milimeters	
	Min.	Max.
A	3.56	4.83
A1	0.50	1.40
A2	2.00	2.92
b	0.38	1.02
b2	1.14	1.78
c	0.31	0.61
D	14.22	16.51
D1	8.38	9.02
E	9.65	10.67
e	2.49	2.59
e1	5.03	5.18
H1	5.84	6.86
L	12.70	14.74
L1		6.35
P	3.53	4.09
Q	2.54	3.43

**Mounting Torque**

**1 N.m**

(\*) Limiting values and life support applications, see Web page.